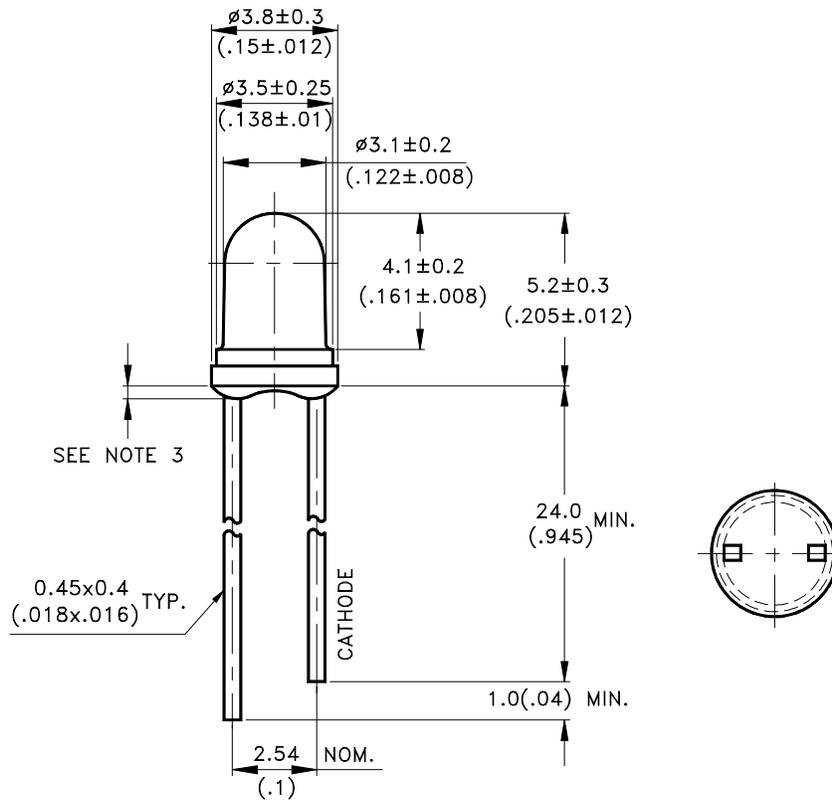


Property of Lite-On Only

### Features

- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on P.C. Board or panel.
- \* I.C. Compatible/low current requirement.
- \* 3.1 mm diameter package.

### Package Dimensions



Part No.	Lens	Source Color
LTL-1CHCE-0G1A	Red Transparent	AlGaAs Red

### NOTES:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25$ mm(.010") unless otherwise noted.
3. Protruded resin under flange is 1.0mm(.04") max.
4. Lead spacing is measured where the leads emerge from the package.
5. Specifications are subject to change without notice.



**Absolute Maximum Ratings at TA=25°C**

Parameter	Maximum Rating	Unit
Power Dissipation	100	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	200	mA
Continuous Forward Current	40	mA
Derating Linear From 50°C	0.5	mA/°C
Reverse Voltage	4	V
Operating Temperature Range	-40°C to + 100°C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

**Electrical Optical Characteristics at TA=25°C**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I <sub>v</sub>	60	250		mcd	I <sub>F</sub> = 20mA Note 1,4
Viewing Angle	2θ <sub>1/2</sub>		45		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λ <sub>p</sub>		660		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ <sub>d</sub>		638		nm	Note 3
Spectral Line Half-Width	Δλ		20		nm	
Forward Voltage	V <sub>F</sub>		1.8	2.4	V	I <sub>F</sub> = 20mA
Reverse Current	I <sub>R</sub>			100	μA	V <sub>R</sub> = 4V
Capacitance	C		30		pF	V <sub>F</sub> = 0, f = 1MHz

Note: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclairage) eye-response curve.

2. θ<sub>1/2</sub> is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength, λ<sub>d</sub> is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

4. The I<sub>v</sub> guarantee should be added ±15%.

## Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

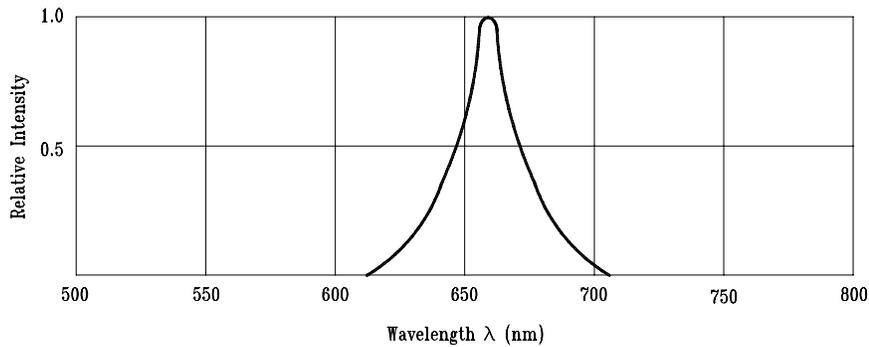


Fig.1 Relative Intensity vs. Wavelength

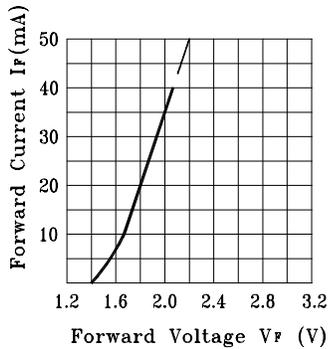


Fig.2 Forward Current vs. Forward Voltage

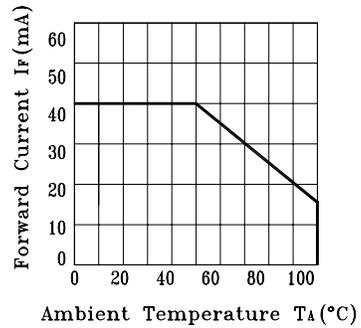


Fig.3 Forward Current Derating Curve

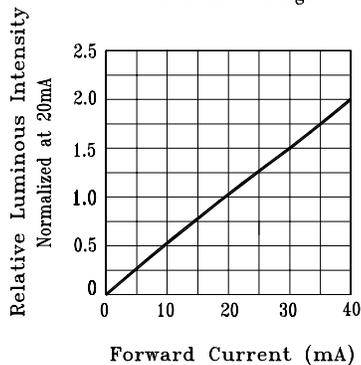


Fig.4 Relative Luminous Intensity vs. Forward Current

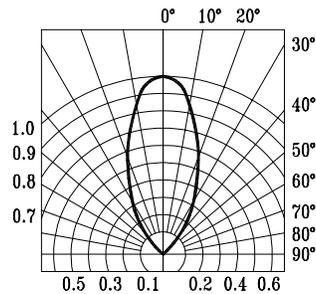


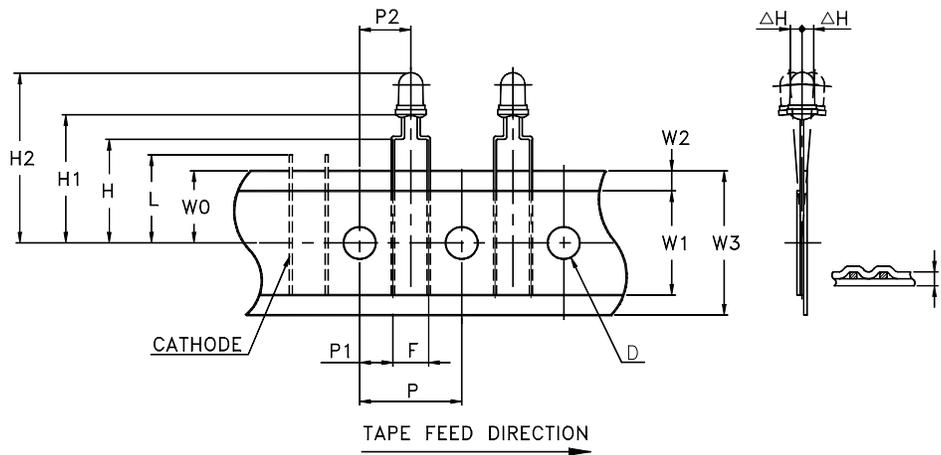
Fig.5 Spatial Distribution

Property of Lite-On Only

### Features

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and folding.
- \* 5mm (0.197") formed lead spacing available.
- \* Folding packaging simplifies handling and testing.

### Package Dimensions



Item	Symbol	Specification			
		Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	4.8	0.188	5.8	0.228
Front to Rear Deflection	$\Delta H$	--	--	2.0	0.078
Height of Seating Plane	H	15.5	0.610	16.5	0.649
Feed Hole to Bottom of Component	H1	20.0	0.787	22.0	0.866
Feed Hole to Overall Component Height	H2	24.9	0.980	27.5	1.083
Lead Length After Component Height	L	W0		11.0	0.433
Feed Hole Pitch	P	12.4	0.488	13.0	0.511
Lead Location	P1	3.15	0.124	4.55	0.179
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Taped Thickness	T	--	--	0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Width	W1	12.5	0.492	13.5	0.531
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748